104935-2 - ACTIVE

AMPMODU | AMPMODU MTE

TE Internal #: 104935-2 PCB Mount Header, Right Angle, Wire-to-Board, 8 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Signal, AMPMODU MTE

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles



Connector System: Wire-to-Board

Number of Positions: 8

Number of Rows: 1

Centerline (Pitch): 2.54 mm [.1 in]

PCB Mount Orientation: Right Angle

Features

Product Type Features

| Connector System | Wire-to-Board |
|------------------|----------------|
| Header Type | Fully Shrouded |
| Sealable | No |

| Printed Circuit Board |
|-----------------------|
| PCB Mount Header |
| |
| 8 |
| 1 |
| Right Angle |
| |
| 15 mΩ |
| 5000 MΩ |
| 600 V |
| |
| Black |
| |
| 5.84 mm[.23 in] |
| .64 mm[.025 in] |
| |

C For support call+1 800 522 6752

PCB Mount Header, Right Angle, Wire-to-Board, 8 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Signal, AMPMODU MTE



| PCB Contact Termination Area Plating Material Thickness | 2.54 – 5.08 μm[100 – 200 μin] |
|---|-------------------------------|
| Contact Mating Area Plating Material Thickness | .381 μm[30 μin] |
| PCB Contact Termination Area Plating Material Finish | Matte |
| Contact Shape & Form | Square |
| PCB Contact Termination Area Plating Material | Tin-Lead |
| Contact Base Material | Brass |
| Contact Mating Area Plating Material | Gold |
| Contact Type | Pin |
| Contact Current Rating (Max) | 3 A |
| Termination Features | |
| Square Termination Post & Tail Dimension | .64 mm[.025 in] |
| Termination Post & Tail Length | 3.3 mm[.13 in] |
| Termination Method to Printed Circuit Board | Through Hole - Solder |
| Mechanical Attachment | |
| Mating Alignment Type | Latched, Polarization |
| Mating Retention | With |
| Mating Retention Type | Polarized Lock |
| Connector Mounting Type | Board Mount |
| Mating Alignment | With |
| PCB Mount Alignment | Without |
| PCB Mount Retention | Without |
| Housing Features | |
| Housing Material | Thermoplastic |
| Centerline (Pitch) | 2.54 mm[.1 in] |
| Dimensions | |
| Connector Length | 22.86 mm[.9 in] |
| Connector Height | 6.99 mm[.275 in] |
| PCB Thickness (Recommended) | 1.57 mm[.062 in] |
| Jsage Conditions | |
| Operating Temperature Range | -65 – 105 °C[-85 – 221 °F] |
| Operation/Application | |
| Circuit Application | Signal |

L For support call+1 800 522 6752

PCB Mount Header, Right Angle, Wire-to-Board, 8 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Signal, AMPMODU MTE



Industry Standards Approved Standards CSA LR7189, UL E28476 UL Flammability Rating UL 94V-0 **Packaging Features** 23 Packaging Quantity Packaging Type Tube **Product Compliance** For compliance documentation, visit the product page on TE.com> Not Compliant EU RoHS Directive 2011/65/EU Compliant with Exemptions EU ELV Directive 2000/53/EC China RoHS 2 Directive MIIT Order No 32, 2016 Restricted Materials Above Threshold EU REACH Regulation (EC) No. 1907/2006 Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) SVHC > Threshold: Pb (13% in Component Part) Article Safe Usage Statements:

Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

Halogen Content

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

PCB Mount Header, Right Angle, Wire-to-Board, 8 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Signal, AMPMODU MTE





Also in the Series | AMPMODU MTE





Wire-to-Board Connector Assemblies & Housings(585)

Wire-to-Board Connector Contacts(32)

Customers Also Bought



PCB Mount Header, Right Angle, Wire-to-Board, 8 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Signal, AMPMODU MTE





Documents

Product Drawings 08 MTE HDR SRRA LATCH

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_104935-2_K.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_104935-2_K.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_104935-2_K.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages AMPMODU MTE INTERCONNECT SYSTEM

English

Product Specifications Application Specification

English